

## Insulated Gate Bipolar Transistor (Ultrafast Speed IGBT), 100 A



SOT-227

**FEATURES**

- Ultrafast: Optimized for minimum saturation voltage and speed up to 40 kHz in hard switching, > 200 kHz in resonant mode
- Very low conduction and switching losses
- Fully isolate package (2500 V<sub>AC</sub>/RMS)
- Very low internal inductance (≤ 5 nH typical)
- Industry standard outline
- UL approved file E78996
- Compliant to RoHS Directive 2002/95/EC
- Designed and qualified for industrial level


**RoHS  
COMPLIANT**

| PRODUCT SUMMARY               |        |
|-------------------------------|--------|
| V <sub>CES</sub>              | 600 V  |
| V <sub>CE(on)</sub> (typical) | 1.92 V |
| V <sub>GE</sub>               | 15 V   |
| I <sub>C</sub>                | 100 A  |

**BENEFITS**

- Designed for increased operating efficiency in power conversion: UPS, SMPS, welding, induction heating
- Lower overall losses available at frequencies = 20 kHz
- Easy to assemble and parallel
- Direct mounting to heatsink
- Lower EMI, requires less snubbing
- Plug-in compatible with other SOT-227 packages

| ABSOLUTE MAXIMUM RATINGS                         |                                   |   |               |                     |
|--|-----------------------------------|---|---------------|---------------------|
| PARAMETER  | SYMBOL                            | TEST CONDITIONS   | MAX.          | UNITS               |
| Collector to emitter breakdown voltage           | V <sub>CES</sub>                  |   | 600           | V                   |
| Continuous collector current                     | I <sub>C</sub>                    | T <sub>C</sub> = 25 °C  | 200           | A                   |
|  |                                   | T <sub>C</sub> = 100 °C   | 100           |                     |
| Pulsed collector current                         | I <sub>CM</sub>                   |   | 400           |                     |
| Clamped inductive load current                   | I <sub>LM</sub>                   | V <sub>CC</sub> = 80 % (V <sub>CES</sub> ), V <sub>GE</sub> = 20 V,<br>L = 10 μH, R <sub>G</sub> = 2.0 Ω,<br>See fig. 13a | 400           |                     |
| Gate to emitter voltage                          | V <sub>GE</sub>                   |   | ± 20          | V                   |
| Reverse voltage avalanche energy                 | E <sub>ARV</sub>                  | Repetitive rating; pulse width limited by maximum junction temperature  | 160           | mJ                  |
| RMS isolation voltage                            | V <sub>ISOL</sub>                 | Any terminal to case, t = 1 minute  | 2500          | V                   |
| Maximum power dissipation                        | P <sub>D</sub>                    | T <sub>C</sub> = 25 °C  | 500           | W                   |
|  |                                   | T <sub>C</sub> = 100 °C   | 200           |                     |
| Operating junction and storage temperature range | T <sub>J</sub> , T <sub>Stg</sub> |   | - 55 to + 150 | °C                  |
| Mounting torque                                  |                                   | 6-32 or M3 screw  | 1.3 (12)      | N · m<br>(lbf · in) |

| THERMAL AND MECHANICAL SPECIFICATIONS |                   |      |      |       |
|---------------------------------------|-------------------|------|------|-------|
| PARAMETER                             | SYMBOL            | TYP. | MAX. | UNITS |
| Junction to case                      | R <sub>thJC</sub> | -    | 0.25 | °C/W  |
| Case to sink, flat, greased surface   | R <sub>thCS</sub> | 0.05 | -    |       |
| Weight of module                      |                   | 30   | -    | g     |



| ELECTRICAL SPECIFICATIONS (T <sub>J</sub> = 25 °C unless otherwise specified) |  |   |   |      |       |       |   |
|---|--|---|---|------|-------|-------|---|
| PARAMETER   | SYMBOL                                 | TEST CONDITIONS   | MIN.                                    | TYP. | MAX.  | UNITS |   |
| Collector to emitter breakdown voltage  | V <sub>(BR)CES</sub>                   | V <sub>GE</sub> = 0 V, I <sub>C</sub> = 250 μA  | 600                                     | -    | -     | V     |   |
| Emitter to collector breakdown voltage  | V <sub>(BR)ECS</sub>                   | V <sub>GE</sub> = 0 V, I <sub>C</sub> = 1.0 A<br>Pulse width ≤ 80 μs; duty factor ≤ 0.1 | 18                                      | -    | -     |       |   |
| Temperature coeff. of breakdown   | ΔV <sub>(BR)CES</sub> /ΔT <sub>J</sub> | V <sub>GE</sub> = 0 V, I <sub>C</sub> = 10 mA   | -                                       | 0.38 | -     | V/°C  |   |
| Collector to emitter saturation voltage                                       | V <sub>CE(on)</sub>                    | I <sub>C</sub> = 100 A  | V <sub>GE</sub> = 15 V<br>See fig. 2, 5 | -    | 1.60  | 1.9   | V |
|   |  | I <sub>C</sub> = 200 A  |   | -    | 1.92  | -     |   |
|   |  | I <sub>C</sub> = 100 A, T <sub>J</sub> = 150 °C   |   | -    | 1.54  | -     |   |
| Gate threshold voltage  | V <sub>GE(th)</sub>                    | V <sub>CE</sub> = V <sub>GE</sub> , I <sub>C</sub> = 250 μA                             | 3.0                                     | -    | 6.0   |       |   |
| Temperature coeff. of threshold voltage                                       | ΔV <sub>GE(th)</sub> /ΔT <sub>J</sub>  | V <sub>CE</sub> = V <sub>GE</sub> , I <sub>C</sub> = 2.0 mA                             | -                                       | - 11 | -     | mV/°C |   |
| Forward transconductance  | g <sub>fe</sub>                        | V <sub>CE</sub> = 100 V, I <sub>C</sub> = 100 A<br>Pulse width 5.0 μs, single shot      | 79                                      | -    | -     | S     |   |
| Zero gate voltage collector current   | I <sub>CES</sub>                       | V <sub>GE</sub> = 0 V, V <sub>CE</sub> = 600 V  | -                                       | -    | 1.0   | mA    |   |
|   |  | V <sub>GE</sub> = 0 V, V <sub>CE</sub> = 600 V, T <sub>J</sub> = 150 °C                 | -                                       | -    | 10    |       |   |
| Gate to emitter leakage current   | I <sub>GES</sub>                       | V <sub>GE</sub> = ± 20 V  | -                                       | -    | ± 250 | nA    |   |

| SWITCHING CHARACTERISTICS (T <sub>J</sub> = 25 °C unless otherwise specified) |                     |   |      |        |      |       |
|---|---------------------|---|------|--------|------|-------|
| PARAMETER   | SYMBOL              | TEST CONDITIONS   | MIN. | TYP.   | MAX. | UNITS |
| Total gate charge (turn-on)   | Q <sub>g</sub>      | I <sub>C</sub> = 100 A<br>V <sub>CC</sub> = 400 V<br>V <sub>GE</sub> = 15 V; See fig. 8   | -    | 770    | 1200 | nC    |
| Gate-emitter charge (turn-on)   | Q <sub>ge</sub>     |   | -    | 100    | 150  |       |
| Gate-collector charge (turn-on)   | Q <sub>gc</sub>     |   | -    | 260    | 380  |       |
| Turn-on delay time  | t <sub>d(on)</sub>  | T <sub>J</sub> = 25 °C<br>I <sub>C</sub> = 100 A<br>V <sub>CC</sub> = 480 V<br>V <sub>GE</sub> = 15 V<br>R <sub>g</sub> = 2.0 Ω<br>Energy losses include "tail"<br>See fig. 9, 10, 14 | -    | 54     | -    | ns    |
| Rise time   | t <sub>r</sub>      |   | -    | 79     | -    |       |
| Turn-off delay time   | t <sub>d(off)</sub> |   | -    | 130    | 200  |       |
| Fall time   | t <sub>f</sub>      |   | -    | 300    | 450  |       |
| Turn-on switching loss  | E <sub>on</sub>     |   | -    | 0.98   | -    |       |
| Turn-off switching loss   | E <sub>off</sub>    | -   | 3.48 | -      |      |       |
| Total switching loss  | E <sub>ts</sub>     | -   | 4.46 | 7.6    |      |       |
| Turn-on delay time  | t <sub>d(on)</sub>  | T <sub>J</sub> = 150 °C<br>I <sub>C</sub> = 100 A, V <sub>CC</sub> = 480 V<br>V <sub>GE</sub> = 15 V, R <sub>g</sub> = 2.0 Ω<br>Energy losses include "tail"<br>See fig. 10, 11, 14   | -    | 56     | -    | ns    |
| Rise time   | t <sub>r</sub>      |   | -    | 75     | -    |       |
| Turn-off delay time   | t <sub>d(off)</sub> |   | -    | 160    | -    |       |
| Fall time   | t <sub>f</sub>      |   | -    | 460    | -    |       |
| Total switching loss  | E <sub>ts</sub>     |   | -    | 7.24   | -    |       |
| Internal emitter inductance   | L <sub>E</sub>      | Measured 5 mm from package  | -    | 5.0    | -    | nH    |
| Input capacitance   | C <sub>ies</sub>    | V <sub>GE</sub> = 0 V<br>V <sub>CC</sub> = 30 V<br>f = 1.0 MHz; See fig. 7  | -    | 16 500 | -    | pF    |
| Output capacitance  | C <sub>oes</sub>    |   | -    | 1000   | -    |       |
| Reverse transfer capacitance  | C <sub>res</sub>    |   | -    | 200    | -    |       |

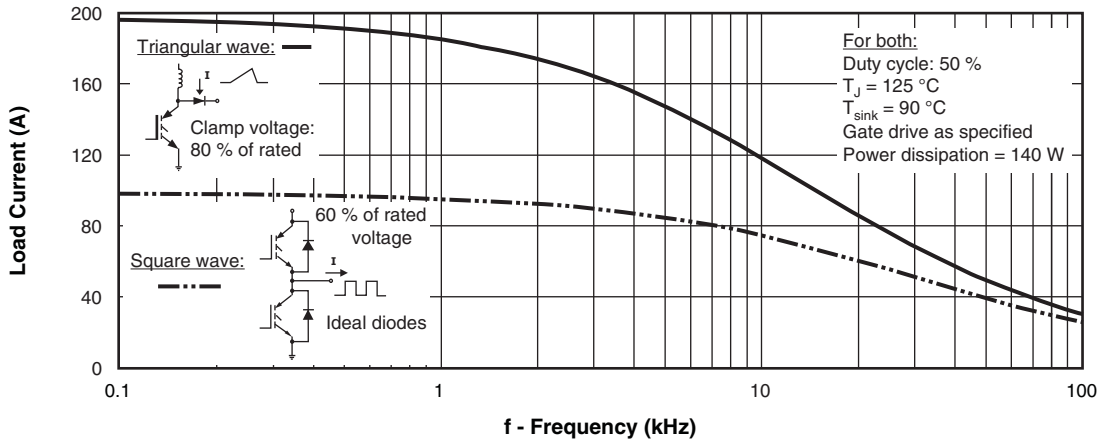


Fig. 1 - Typical Load Current vs. Frequency  
(Load Current =  $I_{RMS}$  of Fundamental)

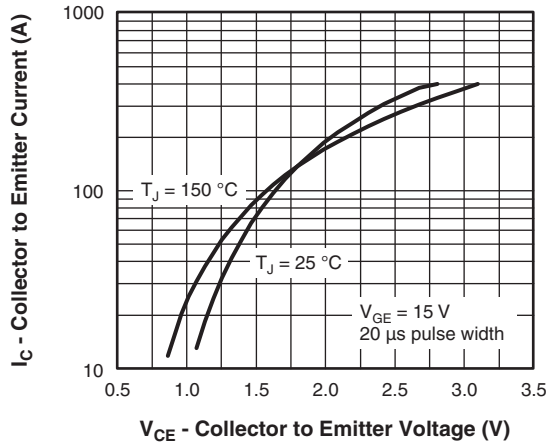


Fig. 2 - Typical Output Characteristics

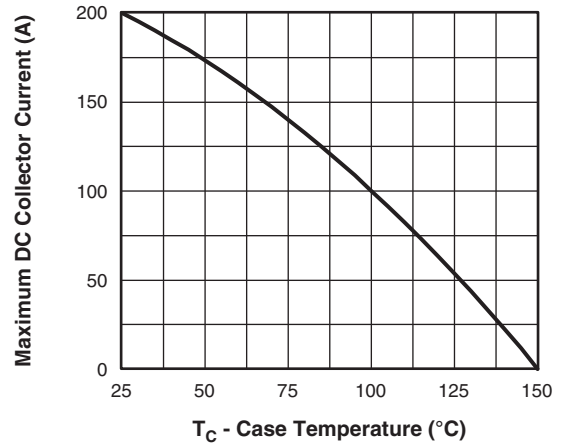


Fig. 4 - Maximum Collector Current vs. Case Temperature

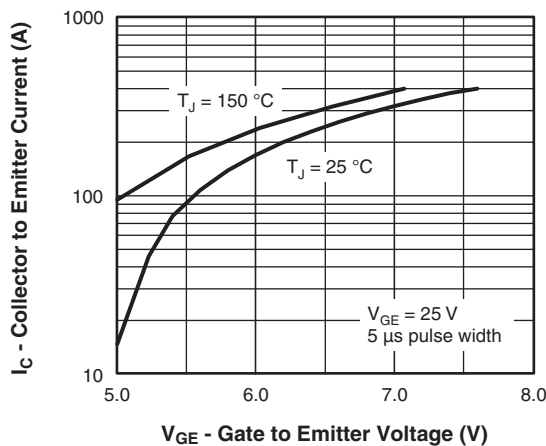


Fig. 3 - Typical Transfer Characteristics

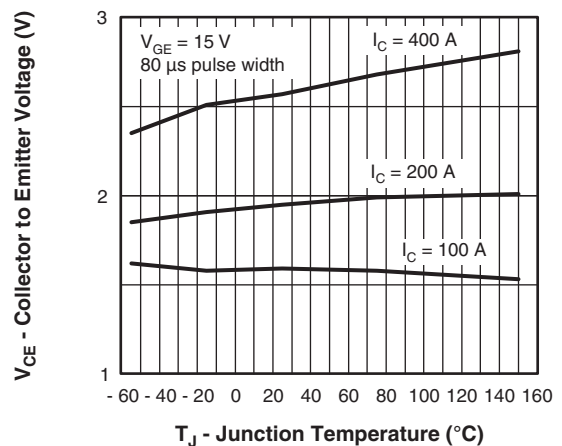


Fig. 5 - Typical Collector to Emitter Voltage vs. Junction Temperature

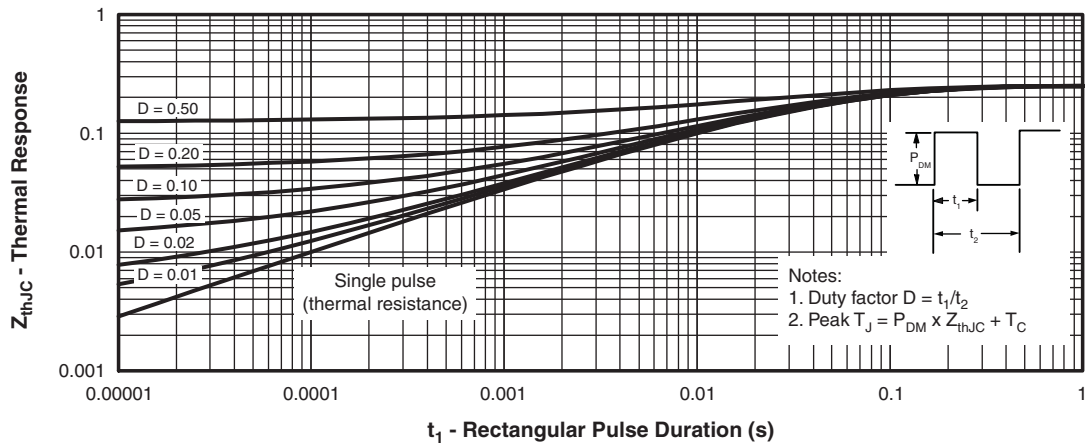


Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction to Case

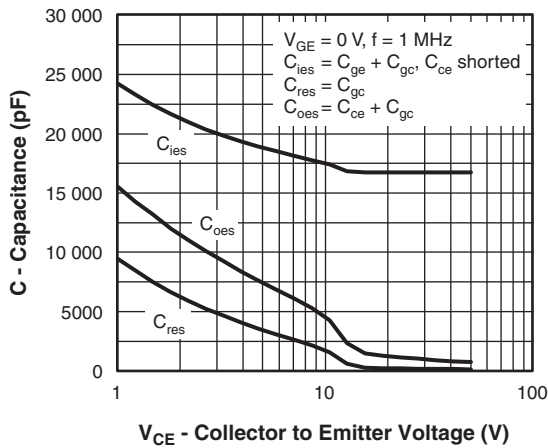


Fig. 7 - Typical Capacitance vs. Collector to Emitter Voltage

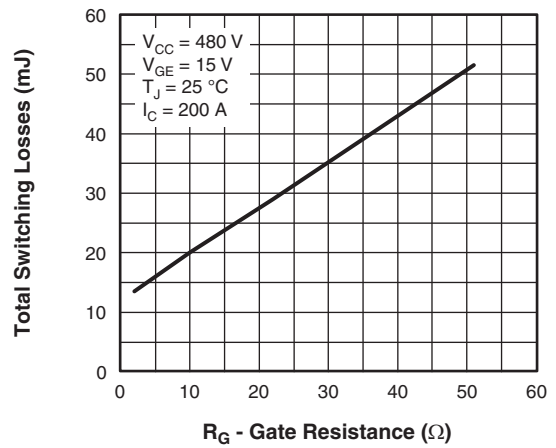


Fig. 9 - Typical Switching Losses vs. Gate Resistance

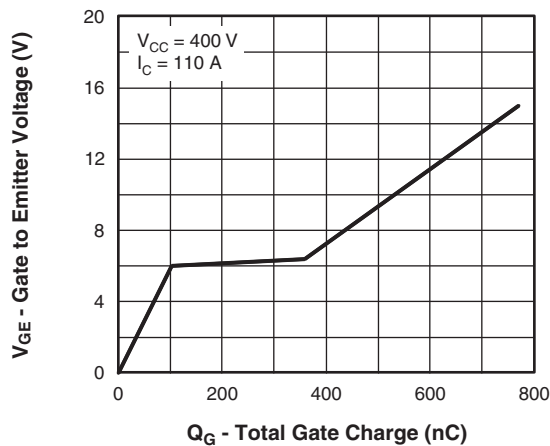


Fig. 8 - Typical Gate Charge vs. Gate to Emitter Voltage

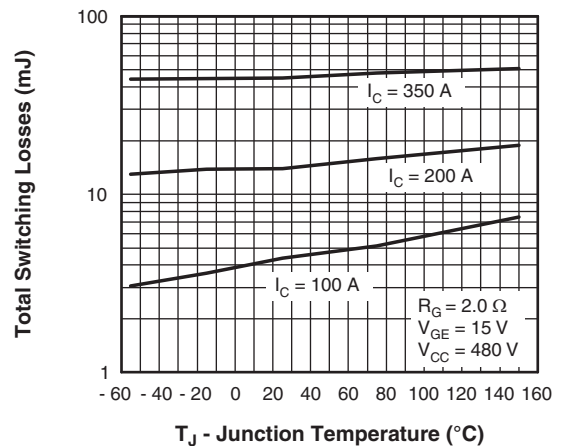


Fig. 10 - Typical Switching Losses vs. Junction Temperature

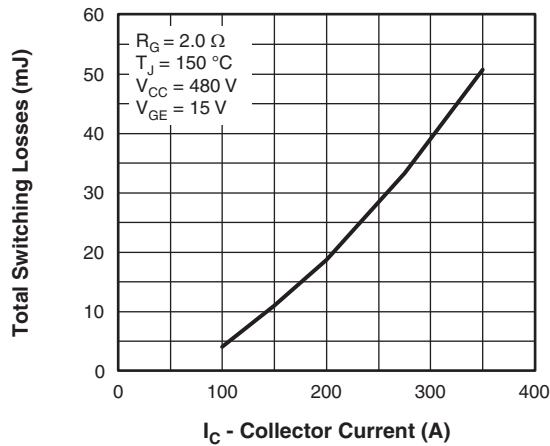


Fig. 11 - Typical Switching Losses vs. Collector Current

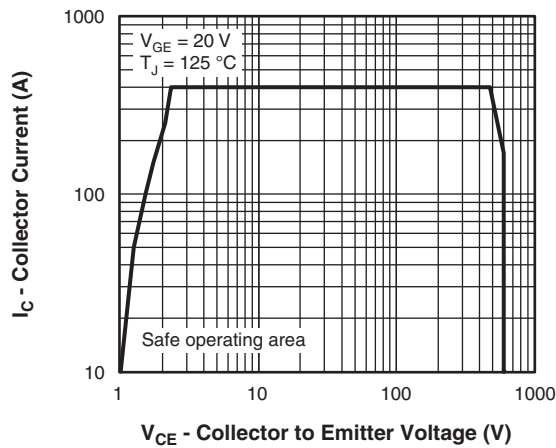
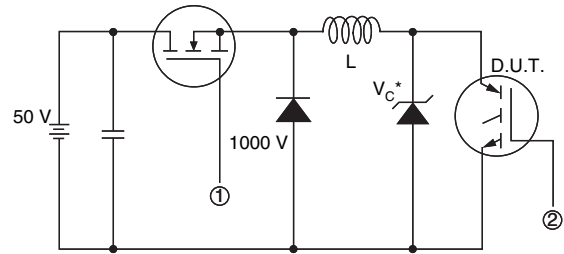


Fig. 12 - Turn-Off SOA



\* Driver same type as D.U.T.;  $V_C = 80\%$  of  $V_{CE}(\text{max})$

**Note:** Due to the 50 V power supply, pulse width and inductor will increase to obtain rated  $I_d$

Fig. 13a - Clamped Inductive Load Test Circuit

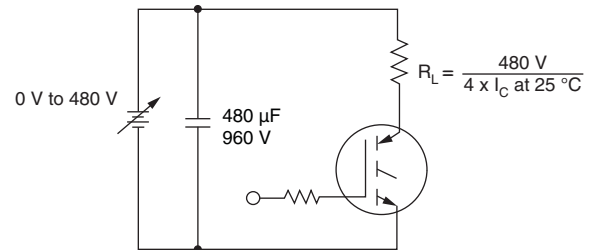
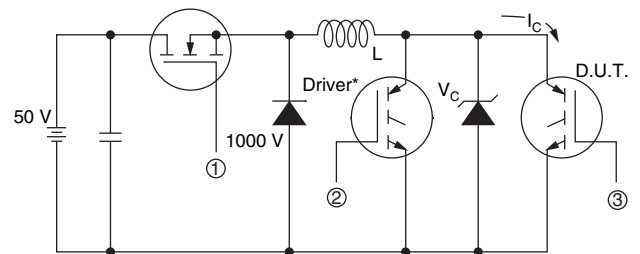


Fig. 13b - Pulsed Collector Current Test Circuit



\* Driver same type as D.U.T.,  $V_C = 480 \text{ V}$

Fig. 14a - Switching Loss Test Circuit

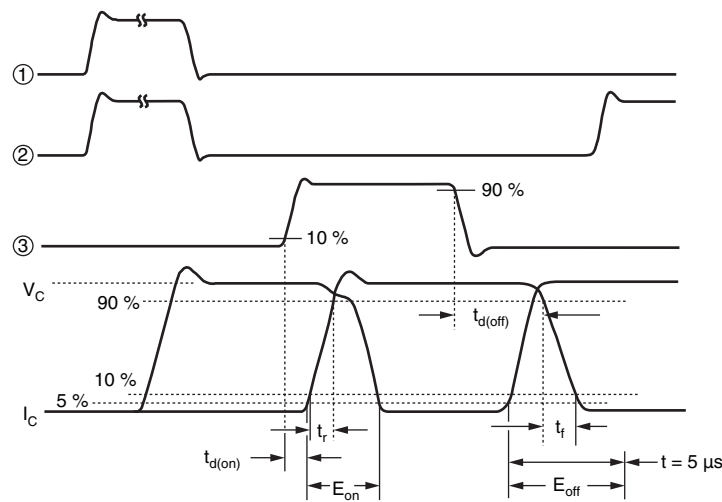
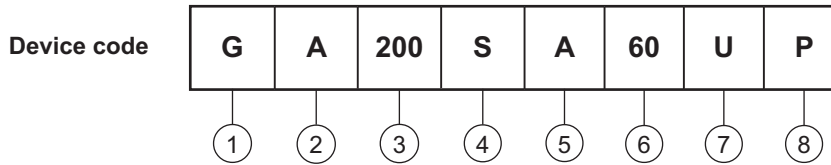
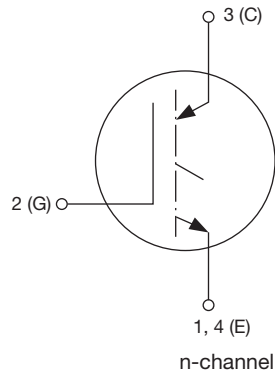


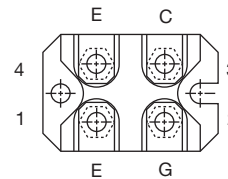
Fig. 14b - Switching Loss Waveforms

**ORDERING INFORMATION TABLE**


- |          |  |
|----------|--|
| <b>1</b> | - Insulated Gate Bipolar Transistor (IGBT)   |
| <b>2</b> | - Generation 4, IGBT silicon, DBC construction   |
| <b>3</b> | - Current rating (200 = 200 A)   |
| <b>4</b> | - Single switch, no diode  |
| <b>5</b> | - SOT-227  |
| <b>6</b> | - Voltage rating (60 = 600 V)  |
| <b>7</b> | - Speed/type (U = Ultrafast)   |
| <b>8</b> | - <ul style="list-style-type: none"> <li>• None = Standard production</li> <li>• P = Lead (Pb)-free</li> </ul> |

**CIRCUIT CONFIGURATION**


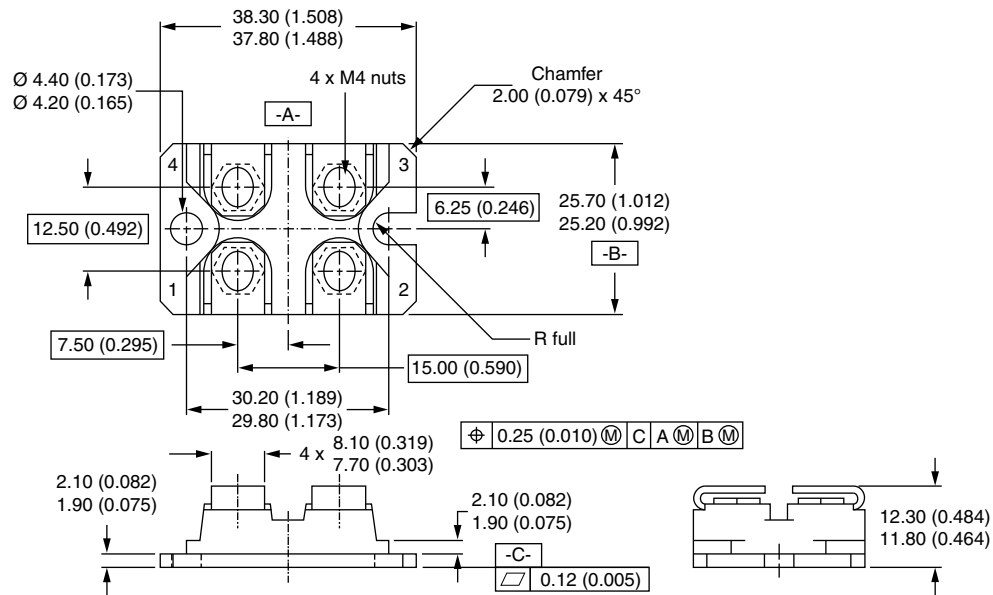
Lead assignment


**LINKS TO RELATED DOCUMENTS**

|                       |  |
|-----------------------|--|
| Dimensions            | <a href="http://www.vishay.com/doc?95036">www.vishay.com/doc?95036</a> |
| Packaging information | <a href="http://www.vishay.com/doc?95037">www.vishay.com/doc?95037</a> |

## SOT-227

**DIMENSIONS** in millimeters (inches)



**Notes**

- Dimensioning and tolerancing per ANSI Y14.5M-1982
- Controlling dimension: millimeter



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